# 7-Channel Multi-Display LED Driver Directive Complianc with Four Integrated LDOs and Flash 

## BD6085GUL

## - General Description

BD6085GUL is Multi-Function LED Driver that is the most suitable for the cellular phone.
It has many functions that are needed to "the upper side" of the cellular phone.

## -Features

- Total 7LEDs driver for LCD Backlight (Main/Sub) and LED Flash
It can set maximum 30 mA by 32 steps (Current DAC) for Main/Sub Display
It can set maximum 360mA for Flash LED driver
(It has 3 channels LED driver at maximum
$120 \mathrm{~mA} / \mathrm{ch}$ for Flash.)
The number of lighting for Main/Sub/Flash LED
can be set up grouping by register.
Ex. ) 4LEDs / OLED / 3LEDs
4LEDs / 1LED / 2LEDs
4LEDs / 2LEDs / 1LED
4LEDs / 1LED / 1LED
5LEDs / 1LED / 1LED
5LEDs / OLED / 2LEDs
6LEDs / OLED / 1LED
It can use the 1LED Flash module to 3LED
Flash module.
Normal mode $=$ maximum $30 \mathrm{~mA} / \mathrm{ch}$,
Flash mode $=x 4$ normal mode (for 3ch LED).

The grouping of LED is independently controlled by register.

- 4ch Series Regulator (LDO) It has selectable output voltage by the register.
LDO1,LDO2 : Iomax=200mA
LDO3,LDO4 : Iomax=150mA
Charge Pump DC/DC for LED driver
It has $\times 1 / \times 1.33 / \times 1.5 / \times 2$ mode that will be selected automatically.
Soft start functions
Over voltage protection (Auto-return type)
Over current protection (Auto-return type)
- Thermal shutdown (Auto-return type)
- $I^{2}$ C BUS FS mode(max 400kHz)Write/Read


## Key Specifications

■ Operating power supply voltage range: 2.7 V to 5.5 V

- LED Maximum setup current Normal mode (LED1 to 7):

30 mA (Тур.)
Flash mode (LED5 to 7):
120mA (Typ.)

- Oscillator frequency:
0.9 MHz (Typ.)
- Operating temperature range: $-35^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
-Package
W(Typ.) x D(Typ.) x H(Max.)
VCSP50L3:
$3.30 \mathrm{~mm} \times 3.30 \mathrm{~mm} \times 0.55 \mathrm{~mm}$
- Typical Application Circuit

Back Light (4ch) + Flash (total 360mA)

## -Pin Configuration [Bottom View]

－Absolute Maximum Ratings（ $\mathrm{Ta}=25^{\circ} \mathrm{C}$ ）

| Parameter | Symbol | Ratings | Unit |
| :--- | :---: | :---: | :---: |
| Maximum voltage | VMAX | 7 | V |
| Power Dissipation | Pd | 1325 | mW |
| Operating Temperature Range | Topr | -35 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | Tstg | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

（note）Power dissipation deleting is $10.6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ ，when it＇s used in over $25{ }^{\circ} \mathrm{C}$ ．
（It＇s deleting is on the board that is ROHM＇s standard）
－Recommended Operating Ratings（VBAT $\geq \mathrm{VIO}, \mathrm{Ta}=-35$ to $85^{\circ} \mathrm{C}$ ）

| Parameter | Symbol | Ratings | Unit |
| :--- | :---: | :---: | :---: |
| VBAT input voltage | VBAT | 2.7 to 5.5 | V |
| VIO pin voltage | VIO | 1.65 to 3.3 | V |

## －Electrical Characteristics

（Unless otherwise specified， $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VBAT}=3.6 \mathrm{~V}, \mathrm{VIO}=1.8 \mathrm{~V}$ ）

| Parameter | Symbol | Limits |  |  | Unit | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． |  |  |
| 【Circuit Current】 |  |  |  |  |  |  |
| VBAT Circuit current 1 | IBAT1 | － | 0.1 | 1.0 | $\mu \mathrm{A}$ | RESETB $=0 \mathrm{~V}$ ，VIO＝0V |
| VBAT Circuit current 2 | IBAT2 | － | 0.5 | 3.0 | $\mu \mathrm{A}$ | RESETB＝0V，VIO $=1.8 \mathrm{~V}$ |
| VBAT Circuit current 3 | IBAT3 | － | 90 | 150 | $\mu \mathrm{A}$ | $\begin{aligned} & \text { LDO1=LDO2=ON, } I_{\text {LDo }}=0 \mathrm{~mA} \\ & \text { Other blocks=OFF } \end{aligned}$ |
| VBAT Circuit current 4 | IBAT4 | － | 90 | 150 | $\mu \mathrm{A}$ | $\begin{aligned} & \text { LDO3=LDO4=ON, ILDo=0mA } \\ & \text { Other blocks=OFF } \end{aligned}$ |
| VBAT Circuit current 5 | IBAT5 | － | 390 | 600 | $\mu \mathrm{A}$ | LDO1＝LDO2＝ON， $\mathrm{I}_{\mathrm{LDO}}=0 \mathrm{~mA}$ DC／DC x1mode， $\mathrm{I}_{\text {LED }}=2.8125(30 \times 3 / 32) \mathrm{mA} \times 4 \mathrm{ch}$ |
| VBAT Circuit current 6 | IBAT6 | － | 61 | 65 | mA | DC／DC x1mode， $\mathrm{I}_{\text {LED }}=60 \mathrm{~mA}$ VBAT $=3.7 \mathrm{~V}$ ，LED Vf＝3．0V |
| VBAT Circuit current 7 | IBAT7 | － | 84 | 94 | mA | $\begin{aligned} & \text { DC/DC } \times 1.33 \mathrm{mode}, I_{\text {LED }}=60 \mathrm{~mA} \\ & \text { VBAT }=3.1 \mathrm{~V}, \mathrm{LED} \mathrm{Vf}=3.0 \mathrm{~V} \end{aligned}$ |
| VBAT Circuit current 8 | IBAT8 | － | 94 | 104 | mA | $\begin{aligned} & \text { DC/DC } \times 1.5 \text { mode, } I_{\text {LED }}=60 \mathrm{~mA} \\ & \text { VBAT }=2.9 \mathrm{~V}, \mathrm{LED} \mathrm{Vf}=3.5 \mathrm{~V} \end{aligned}$ |
| VBAT Circuit current 9 | IBAT9 | － | 128 | 136 | mA | DC／DC $\times 2$ mode， $\mathrm{I}_{\text {LED }}=60 \mathrm{~mA}$ VBAT $=2.9 \mathrm{~V}, \mathrm{LED} \mathrm{Vf}=4.0 \mathrm{~V}$ |
| 【LED Driver】 |  |  |  |  |  |  |
| LED current Step | ILEDSTP |  | 32 |  | Step | LED1 to 7 |
| White LED Maximum setup current | IMAXWLED | － | 30 | － | mA | LED1 to 7 （Normal mode） |
| Flash LED Maximum setup current | IMAXFLED | － | 120 | － | mA | LED5 to 7 （Flash mode） |
| White LED current accuracy | IWLED | －7\％ | 15 | ＋7\％ | mA | $\begin{aligned} & I_{\text {LED }}=15 \mathrm{~mA} \text { setting (Normal mode) } \\ & \text { At VLED }=1.0 \mathrm{~V} \end{aligned}$ |
| Flash LED current accuracy | IFLED | － | 60 | － | mA | $\mathrm{I}_{\text {LED }}=60 \mathrm{~mA}$ setting（Flash mode） At VLED＝1．0V |
| LED current Matching | ILEDMT | － | － | 4 | \％ | Between LED1 to 7 at VLED＝1．0V |
| Flash／Normal current ratio | RATFL | 3.2 | 4 | 4.8 | A／A | LED5 to 7，Flash mode／Normal mode At VLED＝1．0V |
| LED OFF Leak current | ILKLED | － | － | 1.0 | $\mu \mathrm{A}$ | VLED $=4.5 \mathrm{~V}$ |
| 【DC／DC（Charge Pump）】 |  |  |  |  |  |  |
| Maximum Output voltage | VoCP | 4.65 | 5.1 | 5.55 | V |  |
| Current Load | IOUT | － | － | 480 | mA | VBAT $\geq 3.2 \mathrm{~V}, \mathrm{VOUT}=4 \mathrm{~V}$ |
| Oscillator frequency | fosc | 0.72 | 0.9 | 1.08 | MHz |  |
| Over Voltage Protection detect voltage | OVP | 5.0 | 5.5 | 6.0 | V |  |
| Short Circuit current limit | Ilim | － | 250 | 500 | mA | VOUT＝0V |

－Electrical Characteristics－continued（Unless otherwise specified， $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VBAT}=3.6 \mathrm{~V}, \mathrm{VIO}=1.8 \mathrm{~V}$ ）

| Parameter | Symbol | Limits |  |  | Unit | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． |  |  |
| 【I ${ }^{2} \mathrm{C}$ Input（SDA，SCL）】 |  |  |  |  |  |  |
| LOW level input voltage | VIL | －0．3 | － | $\begin{gathered} 0.25 \times \\ \text { VIO } \end{gathered}$ | V |  |
| HIGH level input voltage | VIH | $\begin{gathered} 0.75 \times \\ \text { VIO } \end{gathered}$ | － | $\begin{aligned} & \text { VBAT } \\ & +0.3 \end{aligned}$ | V |  |
| Hysteresis of Schmitt trigger input | Vhys | $\begin{gathered} 0.05 \times \\ \text { VIO } \end{gathered}$ | － | － | V |  |
| LOW level output voltage （SDA）at 3mA sink current | VOL | 0 | － | 0.3 | V |  |
| Input current each I／O pin | lin | －3 | － | 3 | $\mu \mathrm{A}$ | Input voltage $=0.1 \times \mathrm{VIO}$ to $0.9 \times \mathrm{VIO}$ |
| 【RESETB】 |  |  |  |  |  |  |
| LOW level input voltage | VIL | －0．3 | － | $\begin{gathered} 0.25 \times \\ \text { VIO } \end{gathered}$ | V |  |
| HIGH level input voltage | VIH | $\begin{gathered} 0.75 \times \\ \text { VIO } \\ \hline \end{gathered}$ | － | $\begin{aligned} & \text { VBAT } \\ & +0.3 \end{aligned}$ | V |  |
| Input current each I／O pin | lin | －3 | － | 3 | $\mu \mathrm{A}$ | Input voltage $=0.1 \times \mathrm{VIO}$ to $0.9 \times \mathrm{VIO}$ |
| 【Regulator（LDO1）】 |  |  |  |  |  |  |
| Output voltage | Vo1 | 1.164 | 1.20 | 1.236 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 1.261 | 1.30 | 1.339 | V | $1 \mathrm{c}=50 \mathrm{~mA}$ |
|  |  | 1.455 | 1.50 | 1.545 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 1.552 | 1.60 | 1.648 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 1.746 | 1.80 | 1.854 | V | Io＝50mA＜Initial Voltage＞ |
|  |  | 2.134 | 2.20 | 2.266 | V | $10=50 \mathrm{~mA}$ |
|  |  | 2.328 | 2.40 | 2.472 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 2.425 | 2.50 | 2.575 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.522 | 2.60 | 2.678 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.619 | 2.70 | 2.781 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.716 | 2.80 | 2.884 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.813 | 2.90 | 2.987 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 2.910 | 3.00 | 3.090 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 3.007 | 3.10 | 3.193 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.104 | 3.20 | 3.296 | V | $1 \mathrm{o}=50 \mathrm{~mA}$ |
|  |  | 3.201 | 3.30 | 3.399 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
| Output Current | lo1 | － | － | 200 | mA | $\mathrm{Vo}=1.8 \mathrm{~V}$ |
| Dropout Voltage | Vsat1 | － | 0.2 | 0.3 | V | $\mathrm{VBAT}=2.5 \mathrm{~V}, \mathrm{Io}=200 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Load stability | $\Delta \mathrm{Vo11}$ | － | 10 | 60 | mV | $\mathrm{lo}=1$ to $200 \mathrm{~mA}, \mathrm{Vo}=1.8 \mathrm{~V}$ |
| Input voltage stability | $\Delta \mathrm{Vo} 12$ | － | 10 | 60 | mV | VBAT $=3.4$ to 4.5 V ， $\mathrm{lo}=50 \mathrm{~mA}, \mathrm{Vo}=1.8 \mathrm{~V}$ |
| Ripple Rejection Ratio | RR1 | － | 65 | － | dB | $\begin{aligned} & f=100 \mathrm{~Hz}, \mathrm{Vin}=200 \mathrm{mVp}-\mathrm{p}, \mathrm{Vo}=1.2 \mathrm{~V} \\ & \mathrm{lo}=50 \mathrm{~mA}, B W=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz} \end{aligned}$ |
| Short circuit current limit | llim1 | － | 250 | 500 | mA | $\mathrm{Vo}=0 \mathrm{~V}$ |
| Discharge resistor at OFF | ROFF1 | － | 1.0 | 1.5 | $\mathrm{k} \Omega$ |  |

－Electrical Characteristics－continued（Unless otherwise specified， $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VBAT}=3.6 \mathrm{~V}, \mathrm{VIO}=1.8 \mathrm{~V}$ ）

| Parameter | Symbol | Limits |  |  | Unit | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． |  |  |
| 【Regulator（LDO2）】 |  |  |  |  |  |  |
| Output voltage | Vo2 | 1.164 | 1.20 | 1.236 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.261 | 1.30 | 1.339 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.455 | 1.50 | 1.545 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.552 | 1.60 | 1.648 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.746 | 1.80 | 1.854 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.134 | 2.20 | 2.266 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.328 | 2.40 | 2.472 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.425 | 2.50 | 2.575 | V | Io $=50 \mathrm{~mA}$＜lnitial Voltage＞ |
|  |  | 2.522 | 2.60 | 2.678 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.619 | 2.70 | 2.781 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.716 | 2.80 | 2.884 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.813 | 2.90 | 2.987 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.910 | 3.00 | 3.090 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.007 | 3.10 | 3.193 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.104 | 3.20 | 3.296 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.201 | 3.30 | 3.399 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
| Output Current | 102 | － | － | 200 | mA | $\mathrm{Vo}=2.5 \mathrm{~V}$ |
| Dropout Voltage | Vsat2 | － | 0.2 | 0.3 | V | VBAT $=2.5 \mathrm{~V}, \mathrm{Io}=200 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Load stability | 4vo21 | － | 10 | 60 | mV | $\mathrm{Io}=1$ to $200 \mathrm{~mA}, \mathrm{Vo}=2.5 \mathrm{~V}$ |
| Input voltage stability | $\Delta \mathrm{vo} 22$ | － | 10 | 60 | mV | VBAT $=3.4$ to $4.5 \mathrm{~V}, \mathrm{Io}=50 \mathrm{~mA}, \mathrm{Vo}=2.5 \mathrm{~V}$ |
| Ripple Rejection Ratio | RR2 | － | 65 | － | dB | $\begin{aligned} & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{Vin}=200 \mathrm{mVp}-\mathrm{p}, \mathrm{Vo}=1.2 \mathrm{~V} \\ & \mathrm{lo}=50 \mathrm{~mA}, \mathrm{BW}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz} \end{aligned}$ |
| Short circuit current limit | llim2 | － | 250 | 500 | mA | $\mathrm{Vo}=0 \mathrm{~V}$ |
| Discharge resistor at OFF | ROFF2 | － | 1.0 | 1.5 | $\mathrm{k} \Omega$ |  |
| 【Regulator（LDO3）】 |  |  |  |  |  |  |
| Output voltage | Vo3 | 1.164 | 1.20 | 1.236 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.261 | 1.30 | 1.339 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.455 | 1.50 | 1.545 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.552 | 1.60 | 1.648 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.746 | 1.80 | 1.854 | V | Io $=50 \mathrm{~mA}$＜lnitial Voltage＞ |
|  |  | 2.134 | 2.20 | 2.266 | V | $10=50 \mathrm{~mA}$ |
|  |  | 2.328 | 2.40 | 2.472 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.425 | 2.50 | 2.575 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.522 | 2.60 | 2.678 | V | $\mathrm{lo}=50 \mathrm{~mA}$ |
|  |  | 2.619 | 2.70 | 2.781 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.716 | 2.80 | 2.884 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.813 | 2.90 | 2.987 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.910 | 3.00 | 3.090 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.007 | 3.10 | 3.193 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.104 | 3.20 | 3.296 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.201 | 3.30 | 3.399 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
| Output Current | lo3 | － | － | 150 | mA | V o $=1.8 \mathrm{~V}$ |
| Dropout Voltage | Vsat3 | － | 0.2 | 0.3 | V | VBAT $=2.5 \mathrm{~V}, \mathrm{lo}=150 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Load stability | －vo31 | － | 10 | 60 | mV | $\mathrm{lo}=1$ to $150 \mathrm{~mA}, \mathrm{Vo}=1.8 \mathrm{~V}$ |
| Input voltage stability | $\Delta \mathrm{vo} 32$ | － | 10 | 60 | mV | VBAT $=3.4$ to $4.5 \mathrm{~V}, \mathrm{lo}=50 \mathrm{~mA}, \mathrm{Vo}=1.8 \mathrm{~V}$ |
| Ripple Rejection Ratio | RR3 | － | 65 | － | dB | $\begin{aligned} & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{Vin}=200 \mathrm{mVp}-\mathrm{p}, \mathrm{Vo}=1.2 \mathrm{~V} \\ & \mathrm{lo}=50 \mathrm{~mA}, \mathrm{BW}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz} \end{aligned}$ |
| Short circuit current limit | Ilim3 | － | 200 | 400 | mA | $\mathrm{Vo}=0 \mathrm{~V}$ |
| Discharge resistor at OFF | ROFF3 | － | 1.0 | 1.5 | $\mathrm{k} \Omega$ |  |

－Electrical Characteristics－continued（Unless otherwise specified， $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VBAT}=3.6 \mathrm{~V}, \mathrm{VIO}=1.8 \mathrm{~V}$ ）

| Parameter | Symbol | Limits |  |  | Unit | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． |  |  |
| 【Regulator（LDO4）】 |  |  |  |  |  |  |
| Output voltage | Vo4 | 1.164 | 1.20 | 1.236 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.261 | 1.30 | 1.339 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.455 | 1.50 | 1.545 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.552 | 1.60 | 1.648 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 1.746 | 1.80 | 1.854 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.134 | 2.20 | 2.266 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.328 | 2.40 | 2.472 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.425 | 2.50 | 2.575 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.522 | 2.60 | 2.678 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.619 | 2.70 | 2.781 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.716 | 2.80 | 2.884 | V | Io＝50mA＜Initial Voltage＞ |
|  |  | 2.813 | 2.90 | 2.987 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 2.910 | 3.00 | 3.090 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.007 | 3.10 | 3.193 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.104 | 3.20 | 3.296 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
|  |  | 3.201 | 3.30 | 3.399 | V | $1 \mathrm{l}=50 \mathrm{~mA}$ |
| Output Current | lo4 | － | － | 150 | mA | $\mathrm{Vo}=2.8 \mathrm{~V}$ |
| Dropout Voltage | Vsat4 | － | 0.2 | 0.3 | V | VBAT $=2.5 \mathrm{~V}, \mathrm{lo}=150 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Load stability | －vo41 | － | 10 | 60 | mV | $\mathrm{lo}=1$ to $150 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Input voltage stability | $\Delta \mathrm{vo42}$ | － | 10 | 60 | mV | VBAT $=3.4$ to $4.5 \mathrm{~V}, \mathrm{lo}=50 \mathrm{~mA}, \mathrm{Vo}=2.8 \mathrm{~V}$ |
| Ripple Rejection Ratio | RR4 | － | 65 | － | dB | $\begin{aligned} & \mathrm{f}=100 \mathrm{~Hz}, \mathrm{Vin}=200 \mathrm{mVp}-\mathrm{p}, \mathrm{Vo}=1.2 \mathrm{~V} \\ & \mathrm{lo}=50 \mathrm{~mA}, B W=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz} \end{aligned}$ |
| Short circuit current limit | Ilim4 | － | 200 | 400 | mA | V o $=0 \mathrm{~V}$ |
| Discharge resistor at OFF | ROFF4 | － | 1.0 | 1.5 | $\mathrm{k} \Omega$ |  |

（Unless otherwise specified， $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VBAT}=3.6 \mathrm{~V}, \mathrm{VIO}=1.8 \mathrm{~V}$ ）

| Parameter | Symbol | Standard－mode |  |  | Fast－mode |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． | Min． | Typ． | Max． |  |
| 【 ${ }^{2} \mathrm{C}$ BUS format】 |  |  |  |  |  |  |  |  |
| SCL clock frequency | fscl | 0 | － | 100 | 0 | － | 400 | kHz |
| LOW period of the SCL clock | tLow | 4.7 | － | － | 1.3 | － | － | $\mu \mathrm{s}$ |
| HIGH period of the SCL clock | thigh | 4.0 | － | － | 0.6 | － | － | $\mu \mathrm{s}$ |
| Hold time（repeated）START condition After this period，the first clock is generated | thD；STA | 4.0 | － | － | 0.6 | － | － | $\mu \mathrm{s}$ |
| Set－up time for a repeated START condition | tSu；STA | 4.7 | － | － | 0.6 | － | － | $\mu \mathrm{s}$ |
| Data hold time | thD；DAT | 0 | － | 3.45 | 0 | － | 0.9 | $\mu \mathrm{s}$ |
| Data set－up time | tSu；DAT | 250 | － | － | 100 | － | － | ns |
| Set－up time for STOP condition | tsu；STo | 4.0 | － | － | 0.6 | － | － | $\mu \mathrm{s}$ |
| Bus free time between a STOP and START condition | tBUF | 4.7 | － | － | 1.3 | － | － | $\mu \mathrm{s}$ |

## -Pin Descriptions

| No | Ball <br> No. | Pin Name | I/O | ESD Diode |  | Functions | Equivalent Circuit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | For Power | For Ground |  |  |
| 1 | B6 | VBATCP | - | - | GND | Power supply for charge pump | A |
| 2 | F3 | VBAT1 | - | - | GND | Power supply | A |
| 3 | E3 | VBAT2 | - | - | GND | Power supply | A |
| 4 | F5 | VBATLDO1 | - | - | GND | Power supply for LDO | A |
| 5 | F2 | VBATLDO2 | - | - | GND | Power supply for LDO | A |
| 6 | A1 | T1 | 1 | VBAT | GND | Test Input Pin (short to Ground) | S |
| 7 | A6 | T2 | 1 | VBAT | GND | Test Input Pin (short to Ground) | S |
| 8 | F6 | T3 | 0 | VBAT | GND | Test Output Pin (Open) | M |
| 9 | F1 | T4 | 0 | VBAT | GND | Test Output Pin (Open) | N |
| 10 | E6 | VIO | - | VBAT | GND | Power supply for I/O and Digital | C |
| 11 | D3 | RESETB | 1 | VBAT | GND | Reset input (L: reset, H: reset cancel) | H |
| 12 | D5 | SDA | I/O | VBAT | GND | $\mathrm{I}^{2} \mathrm{C}$ data input / output | I |
| 13 | D4 | SCL | 1 | VBAT | GND | $1^{2} \mathrm{C}$ clock input | H |
| 14 | C4 | CPGND | - | VBAT | - | Ground | B |
| 15 | F4 | AGND | - | VBAT | - | Ground | B |
| 16 | B2 | WGND | - | VBAT | - | Ground | B |
| 17 | C2 | FLGND | - | VBAT | - | Ground | B |
| 18 | D6 | C1N | I/O | VBAT | GND | Charge Pump capacitor is connected | F |
| 19 | C6 | C1P | 1/O | - | GND | Charge Pump capacitor is connected | G |
| 20 | C5 | C2N | I/O | VBAT | GND | Charge Pump capacitor is connected | F |
| 21 | B5 | C2P | I/O | - | GND | Charge Pump capacitor is connected | G |
| 22 | A4 | C3N | 1/O | VBAT | GND | Charge Pump capacitor is connected | F |
| 23 | A5 | C3P | I/O | - | GND | Charge Pump capacitor is connected | G |
| 24 | B4 | VOUT | 0 | - | GND | Charge Pump output pin | A |
| 25 | E5 | LDO10 | O | VBAT | GND | LDO1 output pin | Q |
| 26 | E1 | LDO2O | 0 | VBAT | GND | LDO2 output pin | Q |
| 27 | E4 | LDO30 | 0 | VBAT | GND | LDO3 output pin | Q |
| 28 | E2 | LDO40 | 0 | VBAT | GND | LDO4 output pin | Q |
| 29 | A3 | LED1 | 1 | - | GND | LED cathode connection 1 (for Back Light) | E |
| 30 | B3 | LED2 | I | - | GND | LED cathode connection 2 (for Back Light) | E |
| 31 | A2 | LED3 | 1 | - | GND | LED cathode connection 3 (for Back Light) | E |
| 32 | B1 | LED4 | 1 | - | GND | LED cathode connection 4 (for Back Light) | E |
| 33 | C1 | LED5 | I | - | GND | LED cathode connection 5 (for Back Light or Flash) | E |
| 34 | D1 | LED6 | 1 | - | GND | LED cathode connection 6 (for Back Light or Flash) | E |
| 35 | D2 | LED7 | I | - | GND | LED cathode connection 7 (for Back Light or Flash) | E |

[^0]Total: 35Pin

## -Pin ESD Type



## -Block Diagram



## - $1^{2}$ C BUS format

The writing/reading operation is based on the $I^{2} C$ slave standard.

- Slave address

| A7 | A6 | A5 | A4 | A3 | A2 | A1 | R/W |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | $1 / 0$ |

- Bit Transfer

SCL transfers 1-bit data during H . SCL cannot change signal of SDA during H at the time of bit transfer. If SDA changes while SCL is H, START conditions or STOP conditions will occur and it will be interpreted as a control signal.


- START and STOP condition

When SDA and SCL are H , data is not transferred on the $\mathrm{I}^{2} \mathrm{C}$ - bus. This condition indicates, if SDA changes from H to L while SCL has been H , it will become START (S) conditions, and an access start, if SDA changes from L to H while SCL has been $H$, it will become STOP $(P)$ conditions and an access end.


## - Acknowledge

It transfers data 8 bits each after the occurrence of START condition. A transmitter opens SDA after transfer 8bits data, and a receiver returns the acknowledge signal by setting SDA to L .


- Writing protocol

A register address is transferred by the next 1 byte that transferred the slave address and the write-in command. The 3rd byte writes data in the internal register written in by the 2nd byte, and after 4th byte or, the increment of register address is carried out automatically. However, when a register address turns into the last address, it is set to 00h by the next transmission. After the transmission end, the increment of the address is carried out.


- Reading protocol

It reads from the next byte after writing a slave address and R/W bit. The register to read considers as the following address accessed at the end, and the data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.


- Multiple reading protocols

After specifying an internal address, it reads by repeated START condition and changing the data transfer direction. The data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00 h . After the transmission end, the increment of the address is carried out.


As for reading protocol and multiple reading protocols, please do $\bar{A}$ (not acknowledge) after doing the final reading operation. It stops with read when ending by A(acknowledge), and SDA stops in the state of Low when the reading data of that time is 0 . However, this state returns usually when SCL is moved, data is read, and $\bar{A}$ (not acknowledge) is done.

## - Timing diagram



- Register List

| Address | Register data |  |  |  |  |  |  |  | Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |  |
| 00h | - | GRPSET2 | GRPSET1 | GRPSETO | - | - | - | SFTRST | Software Reset <br> LED Lighting group Setting |
| 01h | - | LDO4EN | LDO3EN | LDO2EN | LDO1EN | FLLEDEN | SLEDEN | MLEDEN | Enable Control |
| 02h | - | - | - | IMLED4 | IMLED3 | IMLED2 | IMLED1 | IMLEDO | Main LED Current Setting |
| 03h | - | - | - | ISLED4 | ISLED3 | ISLED2 | ISLED1 | ISLEDO | Sub LED Current Setting |
| 04h | - | - | FLASHEN | IFLLED4 | IFLLED3 | IFLLED2 | IFLLED1 | IFLLEDO | Flash LED Current Setting <br> Flash mode Setting |
| 05h | LDO2VSEL3 | LDO2VSEL2 | LDO2VSEL1 | LDO2VSELO | LDO1VSEL3 | LDO1VSEL2 | LDO1VSEL1 | LDO1VSELO | LDO1 Vout Control LDO2 Vout Control |
| 06h | LDO4VSEL3 | LDO4VSEL2 | LDO4VSEL1 | LDO4VSELO | LDO3VSEL3 | LDO3VSEL2 | LDO3VSEL1 | LDO3VSELO | LDO3 Vout Control LDO4 Vout Control |

Input "0" for "-".
Prohibit to accessing the address that isn't mentioned.

## - Register Map

Address 00h < Software Reset, LED Lighting group Setting >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 00h | R/W | - | GRPSET2 | GRPSET1 | GRPSET0 | - | - | - | SFTRST |
| Initial <br> Value | 00 h | - | 0 | 0 | 0 | - | - | - | 0 |

Bit7 : (Not used)
Bit [6:4] : GRPSET [2:0]

| (Main group) | (Sub group) | (Flash group) |  |
| :---: | :--- | :--- | :--- |
| "000" : | LED1 to 4 | -- | LED5 to 7 |
| "001" : | LED1 to 4 | LED5 | LED6 to 7 |
| "010" : | LED1 to 4 | LED5 to 6 | LED7 |
| "011" : | LED1 to 4 | LED5 | LED7 |
| "100" : | LED1 to 5 | LED6 | LED7 |
| "101" : | LED1 to 5 | -- | LED6 to 7 |
| ""10" : | LED1 to 6 | --- | LED7 |
| "111" : | LED1 to 6 | --- | LED7 |

Bit [3:1] : (Not used)
Bit0 : SFTRST
" 0 ": Reset cancel
"1" : Reset (All register initializing)
Address 01h < Enable Control >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 01h | R/W | - | LDO4EN | LDO3EN | LDO2EN | LDO1EN | FLLEDEN | SLEDEN | MLEDEN |
| Initial <br> Value | 00 h | - | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Bit7: (Not used)
Bit6 : LDO4EN
"0": LDO4 OFF
"1": LDO4 ON
Bit5 : LDO3EN
"0" : LDO3 OFF
"1": LDO3 ON
Bit4: LDO2EN
"0": LDO2 OFF "1" LDO2 ON

Bit3 : LDO1EN
"0" : LDO1 OFF
"1": LDO1 ON
Bit2: FLLEDEN
"0": Flash LED OFF
"1": Flash LED ON
Bit1: SLEDEN
"0": Sub LED OFF
"1" : Sub LED ON
Bit0 : MLEDEN
" 0 ": Main LED OFF
"1": Main LED ON

Address 02h < Main LED Current Setting >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 02h | R/W | - | - | - | IMLED4 | IMLED3 | IMLED2 | IMLED1 | IMLED0 |
| Initial <br> Value | 00 h | - | - | - | 0 | 0 | 0 | 0 | 0 |


| Bit[7:5] : | (Not used) |  |  |
| :---: | :---: | :---: | :---: |
| Bit[4:0] : | IMLED [4:0] |  |  |
|  | "00000" : | 0.9375 mA | (Initial value) |
|  | "00001" | 1.875 mA |  |
|  | "00010" : | 2.8125 mA |  |
|  | "00011" | 3.75 mA |  |
|  | "00100" : | 4.6875 mA |  |
|  | "00101": | 5.625 mA |  |
|  | "00110" | 6.5625 mA |  |
|  | "00111" | 7.5 mA |  |
|  | "01000" : | 8.4375 mA |  |
|  | "01001" : | 9.375 mA |  |
|  | "01010" : | 10.3125 mA |  |
|  | "01011" : | 11.25 mA |  |
|  | "01100" | 12.1875 mA |  |
|  | "01101" : | 13.125 mA |  |
|  | "01110" | 14.0625 mA |  |
|  | "01111" | 15 mA |  |
|  | "10000" | 15.9375 mA |  |
|  | "10001": | 16.875 mA |  |
|  | "10010" : | 17.8125 mA |  |
|  | "10011" | 18.75 mA |  |
|  | "10100" : | 19.6875 mA |  |
|  | "10101": | 20.625 mA |  |
|  | "10110" | 21.5625 mA |  |
|  | "10111" | 22.5 mA |  |
|  | "11000": | 23.4375 mA |  |
|  | "11001": | 24.375 mA |  |
|  | "11010": | 25.3125 mA |  |
|  | "11011": | 26.25 mA |  |
|  | "11100" | 27.1875 mA |  |
|  | "11101": | 28.125 mA |  |
|  | "11110" | 29.0625 mA |  |
|  | "11111" | 30 mA |  |
|  | * LED Curr | rent : $30 \times 1 / 3$ | Step |

Address 03h < Sub LED Current Setting >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 03h | R/W | - | - | - | ISLED4 | ISLED3 | ISLED2 | ISLED1 | ISLED0 |
| Initial <br> Value | 00 h | - | - | - | 0 | 0 | 0 | 0 | 0 |



Address 04h < Flash LED Current Setting, Flash mode Setting >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 04h | R/W | - | - | FLASHEN | IFLLED4 | IFLLED3 | IFLLED2 | IFLLED1 | IFLLED0 |
| Initial <br> Value | 00 h | - | - | 0 | 0 | 0 | 0 | 0 | 0 |

Bit[7:6]: (Not used)
Bit5 : FLASHEN
"0": Flash mode OFF
"1": Flash mode ON (x4 normal mode)
Bit[4:0]: IFLLED [4:0]

| (At FLASHEN=0) (At FLASHEN=1) |  |  | (Initial value) |
| :---: | :---: | :---: | :---: |
| "00000" | 0.9375 mA , | 3.75 mA |  |
| "00001": | 1.875 mA , | 7.5 mA |  |
| "00010" | 2.8125 mA , | 11.25 mA |  |
| "00011" | 3.75 mA , | 15 mA |  |
| "00100" : | 4.6875 mA , | 18.75 mA |  |
| "00101": | 5.625 mA , | 22.5 mA |  |
| "00110" | 6.5625 mA , | 26.25 mA |  |
| "00111" | 7.5 mA , | 30 mA |  |
| "01000" : | 8.4375 mA , | 33.75 mA |  |
| "01001": | 9.375 mA , | 37.5 mA |  |
| "01010" : | 10.3125 mA , | 41.25 mA |  |
| "01011" : | 11.25 mA , | 45 mA |  |
| "01100": | 12.1875 mA , | 48.75 mA |  |
| "01101": | 13.125 mA , | 52.5 mA |  |
| "01110" | 14.0625 mA , | 56.25 mA |  |
| "01111" | 15 mA , | 60 mA |  |
| "10000" | 15.9375 mA , | 63.75 mA |  |
| "10001": | 16.875 mA , | 67.5 mA |  |
| "10010": | 17.8125 mA , | 71.25 mA |  |
| "10011" : | 18.75 mA , | 75 mA |  |
| "10100" : | 19.6875 mA , | 78.75 mA |  |
| "10101": | 20.625 mA , | 82.5 mA |  |
| "10110": | 21.5625 mA , | 86.25 mA |  |
| "10111" | 22.5 mA , | 90 mA |  |
| "11000": | 23.4375 mA , | 93.75 mA |  |
| "11001": | 24.375 mA , | 97.5 mA |  |
| "11010": | 25.3125 mA , | 101.25 mA |  |
| "11011" | 26.25 mA , | 105 mA |  |
| "11100" | 27.1875 mA . | 108.75 mA |  |
| "11101" | 28.125 mA , | 112.5 mA |  |
| "11110": | 29.0625 mA , | 116.25 mA |  |
| "11111" | 30 mA , | 120 mA |  |

* LED Current : $30 \times 1 / 32 \mathrm{~mA}$ Step (at FLASHEN=0), $120 \times 1 / 32 \mathrm{~mA}$ Step (at FLASHEN=1)

Address 05h < LDO1 Vout Control, LDO2 Vout Control >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 05h | R/W | LDO2VSEL3 | LDO2VSEL2 | LDO2VSEL1 | LDO2VSEL0 | LDO1VSEL3 | LDO1VSEL2 | LDO1VSEL1 | LDO1VSEL0 |
| Initial <br> Value | 74 h | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 |

Bit[7:4]: LDO2VSEL [3:0] "0000": 1.20 V "0001": 1.30 V "0010" : 1.50 V "0011": 1.60 V "0100": 1.80 V "0101": 2.20 V "0110": 2.40 V "0111": 2.50 V (Initial value) "1000": 2.60 V "1001": 2.70 V "1010": 2.80 V "1011": 2.90 V "1100": 3.00 V "1101": 3.10 V "1110": 3.20 V "1111": 3.30 V

Bit[3:0] : LDO1VSEL [3:0] "0000": 1.20 V "0001": 1.30 V "0010": 1.50 V "0011": 1.60 V "0100": 1.80 V (Initial value) "0101": 2.20 V "0110": 2.40 V "0111": 2.50 V "1000": 2.60 V "1001": 2.70 V "1010": 2.80 V "1011": 2.90 V "1100": 3.00 V "1101": 3.10 V "1110": 3.20 V "1111" : 3.30 V

Address 06h < LDO3 Vout Control, LDO4 Vout Control >

| Address | R/W | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 06h | R/W | LDO4VSEL3 | LDO4VSEL2 | LDO4VSEL1 | LDO4VSEL0 | LDO3VSEL3 | LDO3VSEL2 | LDO3VSEL1 | LDO3VSEL0 |
| Initial <br> Value | A4h | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 |

Bit[7:4] : LDO4VSEL [3:0] "0000": 1.20 V "0001": 1.30 V "0010" : 1.50 V "0011": 1.60 V "0100": 1.80 V "0101": 2.20 V "0110": 2.40 V "0111": 2.50 V "1000": 2.60 V "1001": 2.70 V "1010" : $\quad 2.80 \mathrm{~V}$ (Initial value) "1011": 2.90 V "1100": 3.00 V "1101": 3.10 V "1110": 3.20 V "1111": 3.30 V

Bit[3:0] : LDO3VSEL [3:0] "0000": 1.20 V "0001": 1.30 V "0010": 1.50 V "0011": 1.60 V "0100": 1.80 V (Initial value) "0101": 2.20 V "0110": 2.40 V "0111" : 2.50 V "1000": 2.60 V "1001": 2.70 V "1010": 2.80 V "1011": 2.90 V "1100": 3.00 V "1101": 3.10 V "1110": 3.20 V "1111" : 3.30 V

## - Explanation for operate

1. Reset

There are two kinds of reset, software reset and hardware reset.
(1) Software reset

- All the registers are initialized more than making a register (SFTRST) setup "1".
- The register of software resetting is an automatic return (Auto Return 0 ).
(2) Hardware reset
- It shifts to hardware reset by changing RESETB pin "H" $\rightarrow$ " L ".
- The condition of all the registers under hardware reset pin is returned to the initial value, and it stops accepting all address.
- It's possible to release from a state of hardware reset by changing RESETB pin " L " $\rightarrow$ " H ".
- RESETB pin has delay circuit. It doesn't recognize as hardware reset in "L" period under $5 \mu \mathrm{~s}$.
(3) Reset Sequence
- When hardware reset was done during software reset, software reset is canceled when hardware reset is canceled. (Because the initial value of software reset is " 0 ")

2. Thermal shutdown

The blocks which thermal shutdown function is effective in the following.
Charge pump
LED Driver
LDO1, LDO2, LDO3, LDO4
A thermal shutdown function works in about $190^{\circ} \mathrm{C}$.
Detection temperature has a hysteresis, and detection release temperature is about $170^{\circ} \mathrm{C}$.
(Design reference value)
3. Charge Pump for LED driver

Charge Pump block is designed for the power supply for LED driver.
It has the $\times 1.0 / \times 1.33 / \times 1.5 / \times 2.0$ mode. it changes to the most suitable mode automatically by Vf of LED and the battery voltage. It has the mode of $\times 1.33$ and it can be higher efficiency than traditional.

Start
Charge Pump circuit operates when any LED turns ON.
Soft start
When the start of the Charge Pump circuit is done, it has the soft start function to prevent a rush current.

(*1) An EN signal in the upper figure means the following;
"EN is high" = Any LED turns ON
But if Ta >TSD, EN Signal doesn't become effective.

Charge Pump Mode transition
The transition of boost multiple transits automatically by Vf of LED and the battery voltage.


BD6085GUL changes the four charge pump movement mode automatically to realize low consumption power.
< Mode Up >
A LED terminal voltage is monitored, and the movement mode is changed to $\times 1 \rightarrow \times 1.33, \times 1.33 \rightarrow \times 1.5$ and $\times 1.5 \rightarrow \times 2$ automatically when a LED terminal voltage is lower than 0.2 V (typ).
At this time, the maximum output voltage of the charge pump is restricted to 5.1 V (typ).
< Mode Down >
The rise in the battery voltage, the off control of LED lighting and the data writing to the address $02 \mathrm{~h}, 03 \mathrm{~h}, 04 \mathrm{~h}$ (LED Current Setting) is monitored, and the movement mode is changed to $\times 2 \rightarrow \times 1.5 \rightarrow \times 1.33 \rightarrow \times 1$ automatically at FLASHEN (Address 04h) $=$ " 0 ". This mode down movement lasts until a mode up movement happens. At FLASHEN="1", the mode down doesn't happen.
The thresholds of rise in a battery voltage are $2.9 \mathrm{~V}, 3.3 \mathrm{~V}, 3.7 \mathrm{~V}$ and 4.1 V (typ).
And, as for the off control of LED lighting, it is shown that MLEDEN, SLEDEN and FLLEDEN (Address 01h) and FLASHEN (Address 04h) transited in " 1 " $\rightarrow$ " 0 ".

Over Voltage protection / Over Current protection
Charge Pump circuit output (VOUT) is equipped with the over-voltage protection and the over current protection function. A VOUT over-voltage detection voltage is about 5.5 V (typ). (VOUT at the time of rise in a voltage)
A detection voltage has a hysteresis, and a detection release voltage is about 5.1 V (typ).
And, when VOUT output short to ground, input current of the battery terminal is limited by an over current protection function.
4. LED Driver

LED current value setting (for Main/Sub)
Internal circuit fixes maximum current value of LED.
LED current is maximum $30 \mathrm{~mA} / \mathrm{ch}$.
LED current value setting (for Flash)
Internal circuit fixes maximum current value of LED.
When FLASHEN (Address 04h)=0, LED current is maximum 30mA/ch. (Normal mode)
When FLASHEN (Address 04h)=1, LED current change to $\times 4$ of Normal mode. (Flash mode)
At Normal mode, it can use for LCD Backlight or Torch mode of Flash.
At Flash mode, it can use for LED Flash.
The number of LED Lighting
The number of lighting for Main/Sub/Flash LED can be set up grouping by the register GRPSET*
(Address 00h).
The setting of the number of lighting is as the following.
The grouping of LED (Main/Sub/Flash) is independently controlled by register MLEDEN, SLEDEN, FLLEDEN (Address 01h).

| Grouping <br> setting | LED1 | LED2 | LED3 | LED4 | LED5 | LED6 | LED7 | Main/Sub/Flash |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $(0,0,0)$ | Main | Main | Main | Main | Flash | Flash | Flash | $4 / 0 / 3$ |
| $(0,0,1)$ | Main | Main | Main | Main | Sub | Flash | Flash | $4 / 1 / 2$ |
| $(0,1,0)$ | Main | Main | Main | Main | Sub | Sub | Flash | $4 / 2 / 1$ |
| $(0,1,1)$ | Main | Main | Main | Main | Sub | - | Flash | $4 / 1 / 1$ |
| $(1,0,0)$ | Main | Main | Main | Main | Main | Sub | Flash | $5 / 1 / 1$ |
| $(1,0,1)$ | Main | Main | Main | Main | Main | Flash | Flash | $5 / 0 / 2$ |
| $(1,1,0)$ | Main | Main | Main | Main | Main | Main | Flash | $6 / 0 / 1$ |
| $(1,1,1)$ | Main | Main | Main | Main | Main | Main | Flash | $6 / 0 / 1$ |

Grouping setting (*,*,*) means ("GRPSET2","GRPSET1","GRPSET0").
The change of the Grouping setting with turning it on is prohibited. The LED terminal that isn't used must be connected to the ground.

Normal mode/Flash mode
Normal mode and Flash mode change as the figure of the follow.
ILED is set by the register.

5. I/O

When the RESETB pin is Low, the input buffers (SDA and SCL) are disable for the Low consumption power.

6. About the start of LDO1 to LDO4

It must start as follows.

<Start Sequence>
VBAT ON (Enough rise up) $\rightarrow$ VIO ON (Enough rise up) $\rightarrow$ Reset release $\rightarrow$ LDO ON
(Register access acceptable)
<End Sequence>
LDO OFF $\rightarrow$ Reset $\rightarrow$ VIO OFF (Enough fall down) $\rightarrow$ VBAT OFF
7. About the terminal management of the function that isn't used Set up the terminal that isn't used as follows.

The LED terminal which isn't used : Short to ground
Don't do the control concerned with this terminal.
T1, T2 : Short to ground
T3, T4: Open
-PCB pattern of the Power dissipation measuring board


- Power Dissipation (On the ROHM's Standard Board)


Information of the ROHM's standard board
Material: glass-epoxy
Size : Refer to page 22.

## -Operational Notes

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.
(2) Power supply and ground line

Design PCB pattern to provide low impedance for the wiring between the power supply and the ground lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and ground lines. Especially, when there are ground pattern for small signal and ground pattern for large current included the external circuits, please separate each ground pattern. Furthermore, for all power supply pins to ICs, mount a capacitor between the power supply and the ground pin. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.
(3) Ground voltage

Make setting of the potential of the ground pin so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no pins are at a potential lower than the ground voltage including an actual electric transient.
(4) Short circuit between pins and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between pins or between the pin and the power supply or the ground pin, the ICs can break down.
(5) Operation in strong electromagnetic field Be noted that using ICs in the strong electromagnetic field can malfunction them.
(6) Input pins

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input pin. Therefore, pay thorough attention not to handle the input pins, such as to apply to the input pins a voltage lower than the ground respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input pins a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.
(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.
(8) Thermal shutdown circuit (TSD)

This LSI builds in a thermal shutdown (TSD)circuit. When junction temperatures become detection temperature or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.
(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd)in actual states of use.
(10) LDO

Use each output of LDO by the independence. Don't use under the condition that each output is short-circuited because it has the possibility that an operation becomes unstable.
(11) About the rush current

For ICs with more than one power supply, it is possible that rush current may flow instantaneously due to the internal powering sequence and delays. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of wiring.

## Status of this document

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.
If there are any differences in translation version of this document formal version takes priority.

## -Ordering Information



## - Marking Diagram



## -Physical Dimension Tape and Reel Information

VCSP50L3(BD6085GUL)


- Revision History

| Date | Revision |  | Changes |
| :---: | :---: | :--- | :---: |
| 05.Oct.2012 | 001 | New Release |  |

## Notice

## -General Precaution

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[b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
[c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl , $\mathrm{H}_{2} \mathrm{~S}, \mathrm{NH}_{3}, \mathrm{SO}_{2}$, and $\mathrm{NO}_{2}$
[d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
[e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
[f] Sealing or coating our Products with resin or other coating materials
[g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
[h] Use of the Products in places subject to dew condensation
4) The Products are not subject to radiation-proof design.
5) Please verify and confirm characteristics of the final or mounted products in using the Products.
6) In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse) is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
7) De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
8) Confirm that operation temperature is within the specified range described in the product specification.
9) ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## -Precaution for Mounting / Circuit board design

1) When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
2) In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## -Precautions Regarding Application Examples and External Circuits

1) If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2) You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

## -Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

## -Precaution for Storage / Transportation

1) Product performance and soldered connections may deteriorate if the Products are stored in the places where:
[a] the Products are exposed to sea winds or corrosive gases, including $\mathrm{Cl} 2, \mathrm{H} 2 \mathrm{~S}, \mathrm{NH} 3, \mathrm{SO} 2$, and NO 2
[b] the temperature or humidity exceeds those recommended by ROHM
[c] the Products are exposed to direct sunshine or condensation
[d] the Products are exposed to high Electrostatic
2) Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3) Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4) Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## -Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

## -Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

## -Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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[^0]:    ※The LED terminal that isn't used is to short-circuit to the ground. But, the setup of a register concerned with LED that isn't used is prohibited.

